## R1AF~R1MF

# 1.0Amp Surface Mount Fast Recovery Rectifiers

#### **Features**

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- Glass passivated chip junction

### **Mechanical Data**

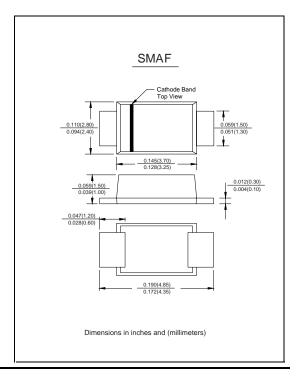
Case: JEDEC SMAF molded plastic body

Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.0014ounce, 0.038 grams



## **Maximum Ratings And Electrical Characteristics**

Ratings at  $25^{\circ}$ C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	R1AF	R1BF	R1DF	R1GF	R1JF	R1KF	R1MF	UNITS
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	VOLTS
Maximum average forward rectified current at T∟=90°C	I(AV)	1.0							Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	Ігѕм				30.0				Amps
Maximum instantaneous forward voltage at 1.0A	VF	1.3							Volts
Maximum DC reverse current TA=25°C at rated DC blocking voltage TA=100°C	lR	5.0 50.0						μΑ	
Maximum reverse recovery time (NOTE 1)	trr		15	0		250	50	00	ns
Typical junction capacitance (NOTE 2)	Cı	15.0						pF	
Typical thermal resistance (NOTE 3)	RθJA	50.0						°C/W	
Operating junction and storage temperature range	Т <sub>J</sub> ,Тsтg	-65 to +150							°C

Note: 1. Reverse recovery condition IF=0.5A, IR=1.0A, Irr=0.25A

2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

3.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas